#### **RESINIFY - TECHNICAL DATA SHEET**

**Product Name:** HighTemp 150 **RT Code:** RT-HT150 **Category:** Engineering Resin – High-Temperature / Heat-Resistant

#### 1. Product Description

HighTemp 150 is an advanced engineering resin formulated for applications requiring elevated thermal resistance, excellent rigidity, and dimensional stability. With a heat deflection temperature (HDT) reaching **150°C**, this material is designed for functional prototypes and tooling that must withstand high heat, hot air, steam, or heated mechanical environments. HighTemp 150 is ideal for mold components, heat-resistant housings, jigs, fixtures, and testing parts used near engines, heating elements, or industrial equipment.

### 2. Key Features & Benefits

- Extremely high heat deflection up to 150°C
- Maintains rigidity under elevated temperatures
- Low shrinkage and high dimensional accuracy
- Excellent mechanical strength and stiffness
- Stable performance for thermal testing and engineering validation
- Compatible with LCD, mSLA, and DLP printers

## 3. Mechanical & Thermal Properties

| Property            | Value           |
|---------------------|-----------------|
| Tensile Strength    | 55–65 MPa       |
| Tensile Modulus     | 2,200-2,900 MPa |
| Elongation at Break | 3–6%            |
| Flexural Strength   | 95–115 MPa      |



| Property         | Value                       |
|------------------|-----------------------------|
| Flexural Modulus | 2,800-3,400 MPa             |
| Impact Strength  | 18–28 J/m                   |
| HDT @ 0.45 MPa   | 140-150°C                   |
| Shore Hardness   | 88–90D                      |
| Shrinkage        | 0.30-0.55%                  |
| Density          | 1.20–1.30 g/cm <sup>3</sup> |
| Viscosity        | 900-1200 cP                 |

Note: Values may vary depending on cure and annealing methods.

# 4. Recommended 3D Printing Parameters

| Parameter       | Setting        |
|-----------------|----------------|
| Printer Type    | LCD, mSLA, DLP |
| Wavelength      | 385–405 nm     |
| Layer Thickness | 50–100 μm      |
| Normal Exposure | 3.2-4.0 sec    |
| Bottom Layers   | 6–10           |
| Bottom Exposure | 45–65 sec      |



| Parameter  | Setting                           |
|------------|-----------------------------------|
| Lift Speed | Medium                            |
| Rest Time  | Recommended for large solid parts |

Important Note: For maximum thermal performance, annealing is highly recommended after UV curing.

## 5. Post-Processing

- 1. Wash: Wash for 3–5 minutes in IPA or a dedicated resin cleaner.
- 2. **Dry**: Dry parts thoroughly.
- 3. Cure: UV post-cure for 30–40 minutes.
- 4. **Anneal for Maximum HDT**: Heat the part to **80°C for 1 hour**, then allow it to cool slowly. Avoid rapid heating or cooling to prevent warping.

## 6. Applications

- High-temperature housings, fixtures, and mold inserts
- Under-hood automotive components
- Functional prototypes requiring heat exposure
- Jigs, fixtures, and industrial equipment parts
- Sterilization-resistant components

### 7. Storage & Handling

- Store in a sealed container between 10–30°C, away from UV light.
- Mix gently before use.
- Shelf Life: 12 months from the date of manufacture when stored properly.

## 8. Compliance

- RoHS
- REACH

• Tested in accordance with ASTM D638, D790, D648.

This document is subject to change. For the latest version, please contact Resinify Technology LLC.

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